

PATENT ASSIGNMENT

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CONVEYING PARTY DATA	
Name	Execution Date
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Property Type	Number
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**EXHIBIT B**

**ASSIGNMENT OF PATENT RIGHTS**

Teledyne Licensing, LLC, a Delaware limited liability company having offices at 1048 Camino Dos Rios, Thousand Oaks, CA 91360, ("**Assignor**"), does hereby sell, assign, transfer, and convey unto Astriphey Applications L.L.C., a Delaware limited liability company, having an office at 2711 Centerville Rd, Suite 400; Wilmington, DE 19808 ("**Assignee**"), all right, title and interest that exist today and may exist in the future in and to the Patents (defined below) which include the patents, patent applications, and provisional patent applications listed in the table below:

<b>Patent No. (Application No.; TL Docket No.)</b>	<b>Country</b>	<b>Issue Date (Filing Date)</b>	<b>Title of Patent and Inventors</b>
6,252,258 (09/371,740; 1999SC068US1)	US	6/26/2001 (8/10/1999)	High power rectifier Hsueh-Rong Chang, Rajesh Gupta
6,252,288 (09/232,787; 1997SC090US1)	US	6/26/2001 (1/19/1999)	High power trench-based rectifier with improved reverse breakdown characteristic Hsueh-Rong Chang
6,380,569 (09/371,741; 1999SC009US1)	US	4/30/2002 (8/10/1999)	High power unipolar FET switch Hsueh-Rong Chang, Rajesh Gupta
6,392,273 (09/483,605; 1999SC037US1)	US	5/21/2002 (1/14/2000)	Trench insulated-gate bipolar transistor with improved safe-operating-area Hsueh-Rong Chang
6,399,998 (09/675,401; 2000SC023US1)	US	6/4/2002 (9/29/2000)	High voltage insulated-gate bipolar switch Hsueh-Rong Chang
6,503,343 (09/658,643; 2000SC049US1)	US	1/7/2003 (9/11/2000)	Controlled plating on reactive metals D. Morgan Tench, Leslie F. Warren, Jr., John T. White
6,906,356 (10/952,268; 2002RSC028US1)	US	6/14/2005 (9/27/2004)	High voltage switch Hsueh-Rong Chang
6,965,131 (10/383,598; 2001SC125US1)	US	11/15/2005 (3/7/2003)	Thyristor switch with turn-off current shunt, and operating method Hsueh-Rong Chang
7,135,740 (10/952,220; 2002RSC015US1)	US	11/14/2006 (9/27/2004)	High voltage FET switch with conductivity modulation Hsueh-Rong Chang
7,173,290 (10/642,085; 2001SC125US2)	US	2/6/2007 (8/15/2003)	Thyristor switch with turn-off current shunt, and operating method Hsueh-Rong Chang
7,247,550 (11/053,800; 2004RSC053US1)	US	7/24/2007 (2/8/2005)	Silicon carbide-based device contact and contact fabrication method Qingchun Zhang

7,390,735 (11/031435; 2003RSC114US1)	US	6/24/2008 (1/7/2005)	High temperature, stable SiC device interconnects and packages having low thermal resistance  Vivek Mehrotra
(12/116,916; 2003RSC114US2)	US	(5/7/2008)	High temperature, stable SiC device interconnects and packages having low thermal resistance  Vivek Mehrotra

The "Patents" further include all right, title, and interest that exist today and may exist in the future in and to any and all of the following:

(a) the provisional patent applications, patent applications and patents listed in the table set forth above;

(b) all patents and patent applications (i) to which any of the Patents directly or indirectly claims priority, and/or (ii) for which any of the Patents directly or indirectly forms a basis for priority;

(c) all reissues, reexaminations, extensions, continuations, continuations in part, continuing prosecution applications, requests for continuing examinations, divisions, and registration of any item in the foregoing categories (a) and (b);

(d) all foreign patents, patent applications, and counterparts relating to any item in the foregoing categories (a) through (c), including, without limitation, certificates of invention, utility models, industrial design protection, design patent protection, and other governmental grants or issuances;

(e) all items in any of the foregoing in categories (a) through (d), whether or not expressly listed as Patents above and whether or not claims in any of the foregoing have been rejected, withdrawn, cancelled, or the like; and

(f) all inventions, invention disclosures, and discoveries described in any item in any of the foregoing categories (a) through (e) and all other rights arising out of such inventions, invention disclosures, and discoveries;

(g) all rights to apply in any or all countries of the world for patents, certificates of invention, utility models, industrial design protections, design patent protections, or other governmental grants or issuances of any type related to any item in any of the foregoing categories (a) through (f), including, without limitation, under the Paris Convention for the Protection of Industrial Property, the International Patent Cooperation Treaty, or any other convention, treaty, agreement, or understanding;

(h) all causes of action and enforcement rights of any kind (whether such claims, causes of action or enforcement rights are known or unknown; currently pending, filed, to be filed, or otherwise) under or on account of any of the Patents and/or any item in any of the foregoing categories (b) through (g), including, without limitation, all causes of action and other enforcement rights for

- (i) damages,
- (ii) injunctive relief, and
- (iii) any other remedies of any kind

for past, current, and future infringement; and

(i) all rights to collect royalties or other payments under or on account of any of the Patents or any of the foregoing.

Assignor hereby authorizes the respective patent office or governmental agency in each jurisdiction to issue any and all patents, certificates of invention, utility models or other governmental grants or issuances that may be granted upon any of the Patent Rights in the name of Assignee, as the assignee to the entire interest therein.

The terms and conditions of this Assignment of Patent Rights will inure to the benefit of Assignee, its successors, assigns, and other legal representatives and will be binding upon Assignor, its successors, assigns, and other legal representatives.

IN WITNESS WHEREOF this Assignment of Patent Rights is executed at 1049 Camino Dos Rios, Thousand Oaks, CA on JAN. 29, 2008. 9

ASSIGNOR:

Teledyne Licensing, LLC

By: William J. Gunning III

Name: William J. Gunning III

Title: Vice President

STATE OF CALIFORNIA )  
 ) ss.  
COUNTY OF VENTURA )

On January 29, 2009, before me, Paula J. Ross, Notary Public in and for said State, personally appeared William J. Gunning III, personally known to me (or proved to me on the basis of satisfactory evidence) to be the person whose name is subscribed to the within instrument and acknowledged to me that he/~~she~~ executed the same in his/~~her~~ authorized capacity, and that by his/~~her~~ signature on the instrument the person, or the entity upon behalf of which the person acted, executed the instrument.

WITNESS my hand and official seal.

Signature Paula J. Ross

